



AO3401A

P-Channel Enhancement Mode Field Effect Transistor

General Description

The AO3401A/L uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation gate voltages as low as 2.5V. This device is suitable for use as a load switch or other general applications. AO3401A and AO3401AL are electrically identical.
 -RoHS Compliant
 -AO3401AL is Halogen Free

Features

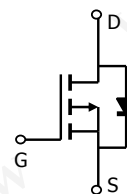
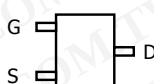
$V_{DS} (V) = -30V$
 $I_D = -4.3A$ ($V_{GS} = -10V$)
 $R_{DS(ON)} < 46m\Omega$ ($V_{GS} = -10V$)
 $R_{DS(ON)} < 55m\Omega$ ($V_{GS} = -4.5V$)
 $R_{DS(ON)} < 80m\Omega$ ($V_{GS} = -2.5V$)

Rg, Ciss, Coss, Crss Tested

**TO-236
(SOT-23)**



Top View



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^{A,F}	I_D	-4.3	A
		-3.8	
Pulsed Drain Current ^B	I_{DM}	-25	
Power Dissipation ^A	P_D	1.4	W
		0.9	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^{AF}	$R_{\theta JA}$	65	90	$^\circ C/W$
Maximum Junction-to-Ambient ^A		85	125	$^\circ C/W$
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	43	80	$^\circ C/W$

Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}$, $V_{GS}=0\text{V}$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-30\text{V}$, $V_{GS}=0\text{V}$ $T_J=55^{\circ}\text{C}$			-1 -5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}$, $V_{GS}=\pm 12\text{V}$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=-250\mu\text{A}$	-0.6	-1	-1.3	V
$I_{D(ON)}$	On state drain current	$V_{GS}=-4.5\text{V}$, $V_{DS}=-5\text{V}$	-25			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-10\text{V}$, $I_D=-4.3\text{A}$ $T_J=125^{\circ}\text{C}$		36 52	44 63	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}$, $I_D=-3.5\text{A}$		44	55	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}$, $I_D=-2.5\text{A}$		62	80	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=-5\text{V}$, $I_D=-4.3\text{A}$		13		S
V_{SD}	Diode Forward Voltage	$I_S=-1\text{A}$, $V_{GS}=0\text{V}$		-0.75	-1	V
I_S	Maximum Body-Diode Continuous Current				-2	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}$, $V_{DS}=-15\text{V}$, $f=1\text{MHz}$		933	1200	pF
C_{oss}	Output Capacitance			108		pF
C_{rss}	Reverse Transfer Capacitance			81		pF
R_g	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $f=1\text{MHz}$		6	9	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	$V_{GS}=-4.5\text{V}$, $V_{DS}=-15\text{V}$, $I_D=-4.3\text{A}$		9.3	12.2	nC
Q_{gs}	Gate Source Charge			1.5		nC
Q_{gd}	Gate Drain Charge			3.7		nC
$t_{D(on)}$	Turn-On DelayTime	$V_{GS}=-10\text{V}$, $V_{DS}=-15\text{V}$, $R_L=3.5\Omega$, $R_{GEN}=6\Omega$		5.2		ns
t_r	Turn-On Rise Time			6.8		ns
$t_{D(off)}$	Turn-Off DelayTime			42		ns
t_f	Turn-Off Fall Time			15		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=-4.3\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		21	28	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=-4.3\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		14.3		nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The SOA curve provides a single pulse rating.

F: The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

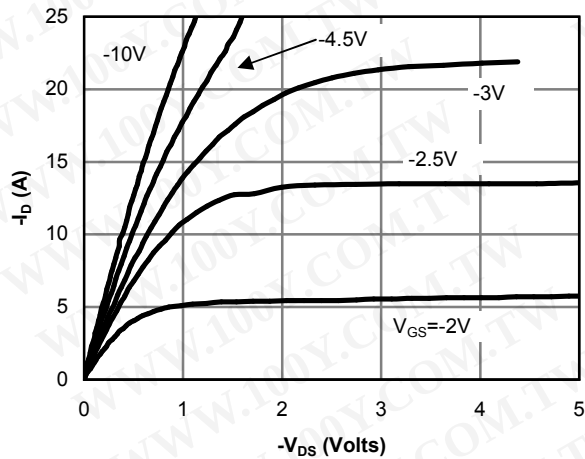


Figure 1: On-Region Characteristics

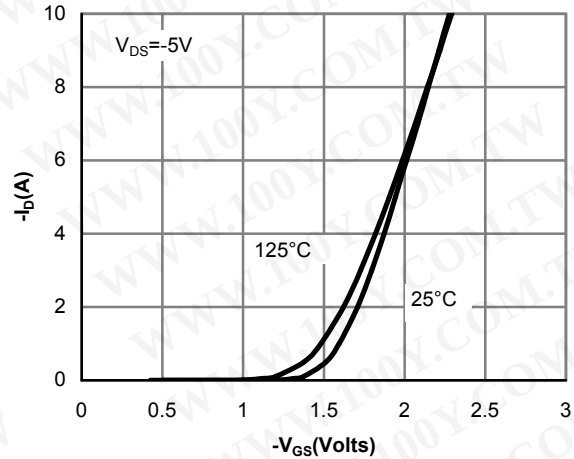


Figure 2: Transfer Characteristics

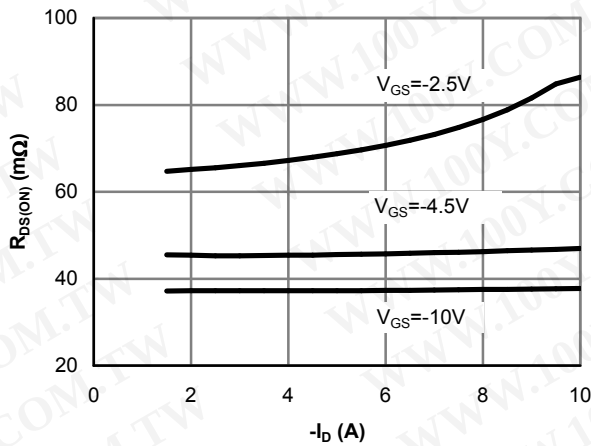


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

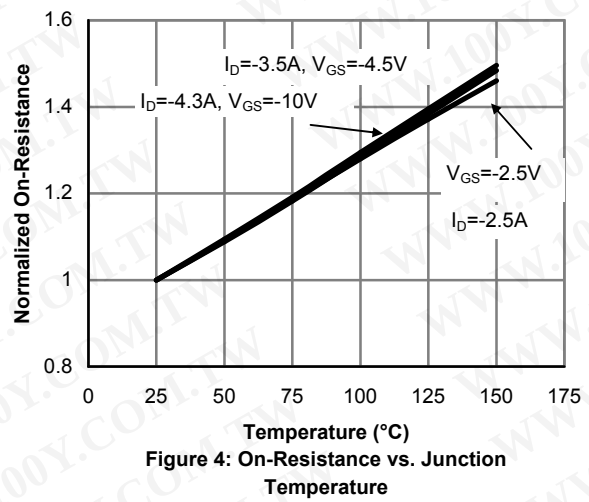


Figure 4: On-Resistance vs. Junction Temperature

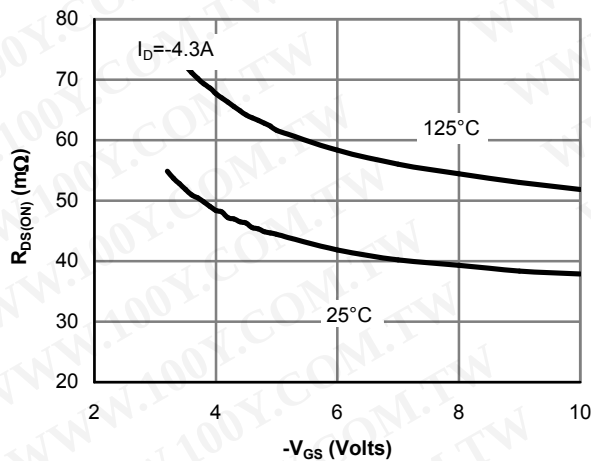


Figure 5: On-Resistance vs. Gate-Source Voltage

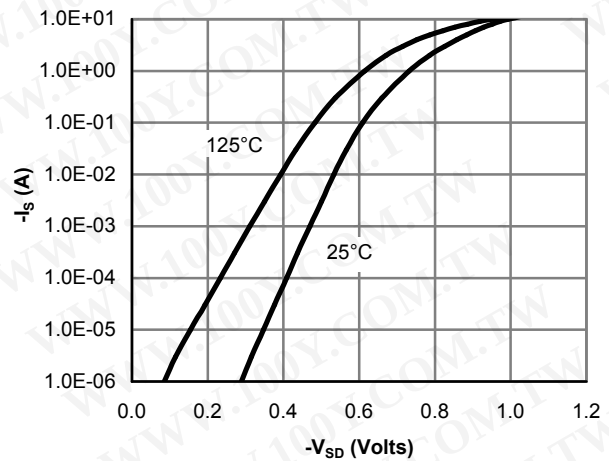
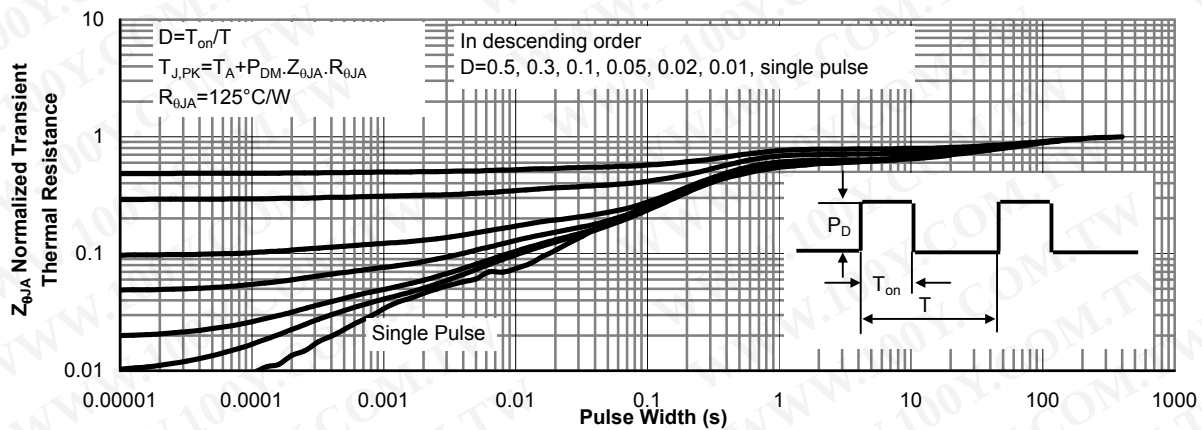
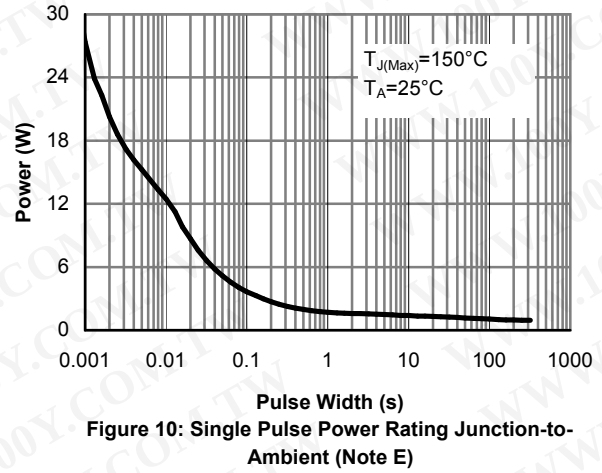
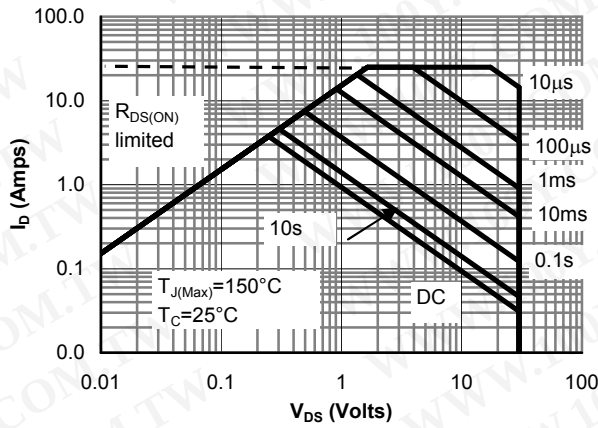
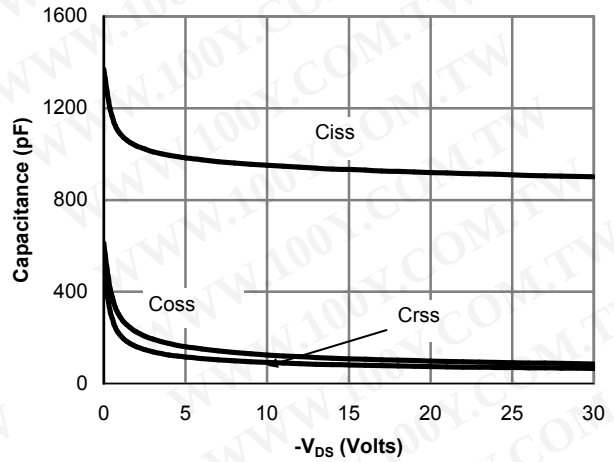
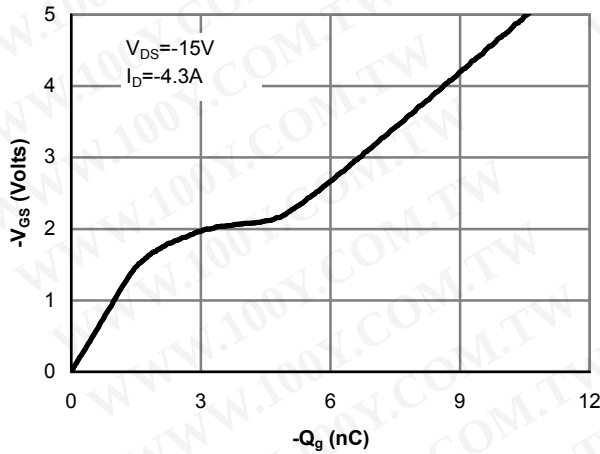
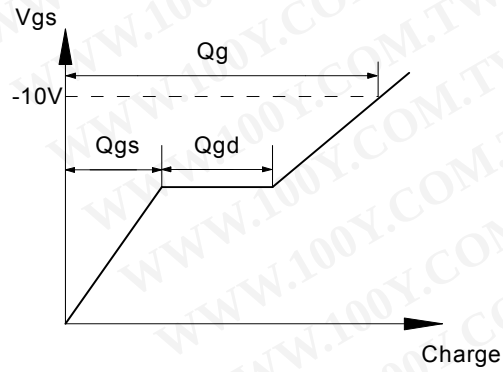
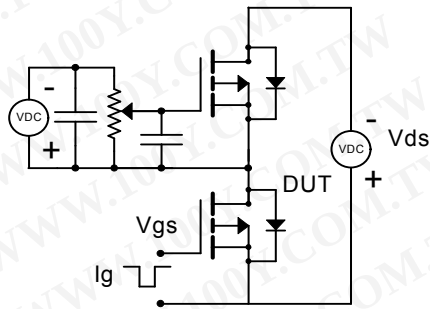


Figure 6: Body-Diode Characteristics

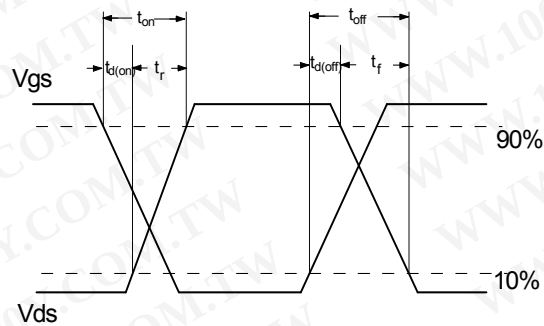
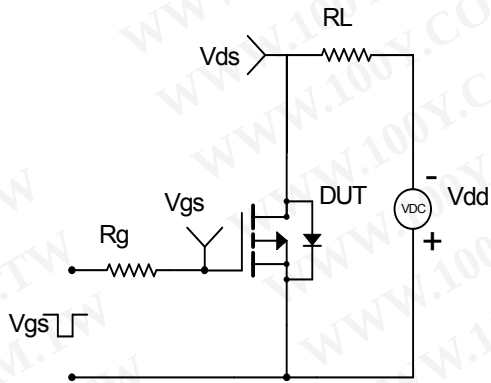
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



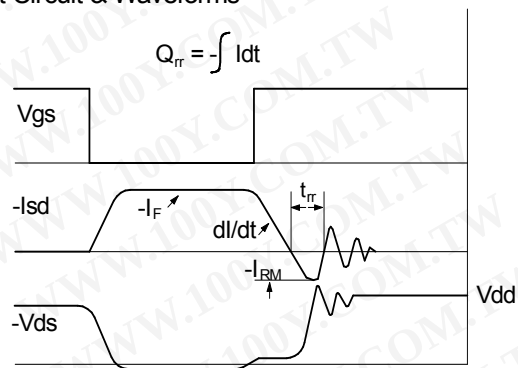
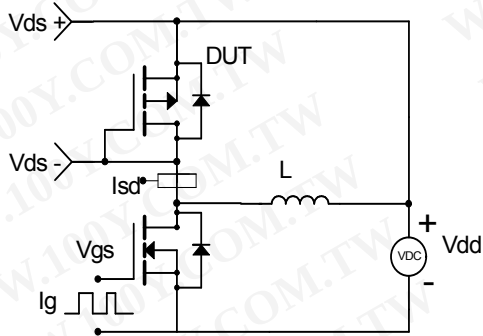
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



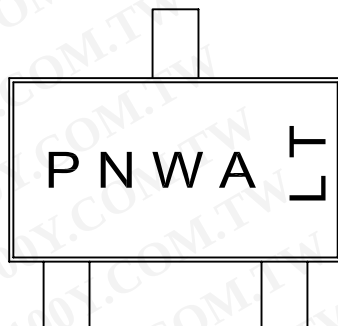
Diode Recovery Test Circuit & Waveforms



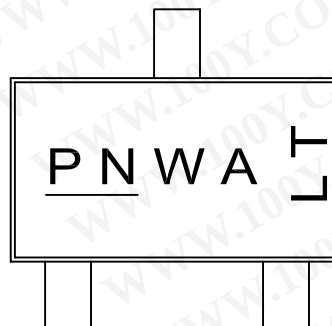


Document No.	PD-00660
Version	A
Title	AO3401A Marking Description

SOT-23 PACKAGE MARKING DESCRIPTION



Standard product



Green product

NOTE:

- P - Package and product type
- N - Last digital of product number
- W - Week code
- A - Assembly location code
- L&T - Assembly lot code

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PART NO.	DESCRIPTION	CODE (PN)
AO3401A	Standard product	X1
AO3401AL	Green product	<u>X1</u>